



## DMTH10H010SPSQ

#### 100V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

#### **Product Summary**

BV <sub>DSS</sub>	DSS R <sub>DS(ON)</sub> Max I <sub>D</sub> (Note 1	
100\/	8.8mΩ @ V <sub>GS</sub> = 10V	100A
100V	11.5mΩ @ V <sub>GS</sub> = 6V	100A

### Description

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP.

# Applications

- Motor Control
- DC-DC Converters
- Power Management

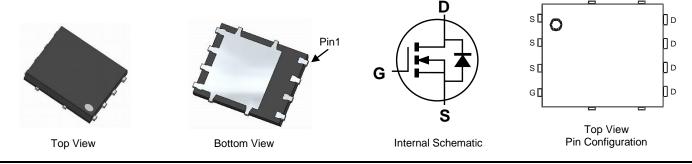
# Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low R<sub>DS(ON)</sub> Minimizes On-State Losses
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

### Mechanical Data

- Case: PowerDI<sup>®</sup>5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)





# Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH10H010SPSQ-13	PowerDI5060-8	2,500 / Tape & Reel

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See http://www.diodes.com/quality/lead\_free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.

5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

#### **Marking Information**

Notes:



J : = Manufacturer's Marking
TH10H010S = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 18 = 2018)
WW = Week Code (01 to 53)

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# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V <sub>DSS</sub>	100	V	
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 6)	T <sub>A</sub> = +25°C T <sub>A</sub> = +100°C	ID	11.8 8.3	А
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 7)	T <sub>C</sub> = +25°C (Note 10) T <sub>C</sub> = +100°C	۱ <sub>D</sub>	100 87	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	250	А	
Maximum Continuous Body Diode Forward Current	Is	100	A	
Avalanche Current, L = 0.3mH	I <sub>AS</sub>	25	A	
Avalanche Energy, L = 0.3mH	Eas	93.7	mJ	
Avalanche Current (Note 8), L = 3mH	I <sub>AS</sub>	14.3	А	
Avalanche Energy (Note 8), L = 3mH	E <sub>AS</sub>	307	mJ	

# **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	1.5	W
Thermal Resistance, Junction to Ambient (Note 6)		R <sub>0JA</sub>	99	°C/W
Total Power Dissipation (Note 7)	T <sub>C</sub> = +25°C	PD	166	W
Thermal Resistance, Junction to Case (Note 7)	R <sub>θJC</sub>	0.9	°C/W	
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +175	°C	

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	100	—	—	V	$V_{GS} = 0V$ , $I_D = 1mA$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	—	1	μA	$V_{DS} = 80V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS		—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	2	—	4	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	
Static Drain-Source On-Resistance			6.6	8.8	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> = 13A	
	R <sub>DS(ON)</sub>		8.5	11.5	11122	$V_{GS} = 6V, I_D = 13A$	
Diode Forward Voltage	V <sub>SD</sub>		0.8	1.3	V	$V_{GS} = 0V, I_{S} = 13A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss		4468	—		$V_{DS} = 50V, V_{GS} = 0V$ f = 1MHz	
Output Capacitance	Coss	-	746	—	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>		32	—			
Gate Resistance	Rg	-	0.91	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Qg	_	56.4	_		V/ 50V/1 40A	
Gate-Source Charge	Q <sub>gs</sub>	_	15.4	—	nC	$V_{DD} = 50V, I_D = 13A,$ $V_{GS} = 10V$	
Gate-Drain Charge	Q <sub>gd</sub>	_	14	—			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	18.6	_		V <sub>DD</sub> = 50V, V <sub>GS</sub> = 10V,	
Turn-On Rise Time	t <sub>R</sub>	_	22.5	_			
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	44.8	_	ns	$I_D = 13A, R_g = 6\Omega$	
Turn-Off Fall Time	tF	-	29.5	_			
Reverse Recovery Time	t <sub>RR</sub>	_	54.5	_	ns	1 12 A di/dt 100 A /up	
Reverse Recovery Charge	Q <sub>RR</sub>	_	106.4	_	nC	I <sub>F</sub> = 13A, di/dt = 100A/μs	

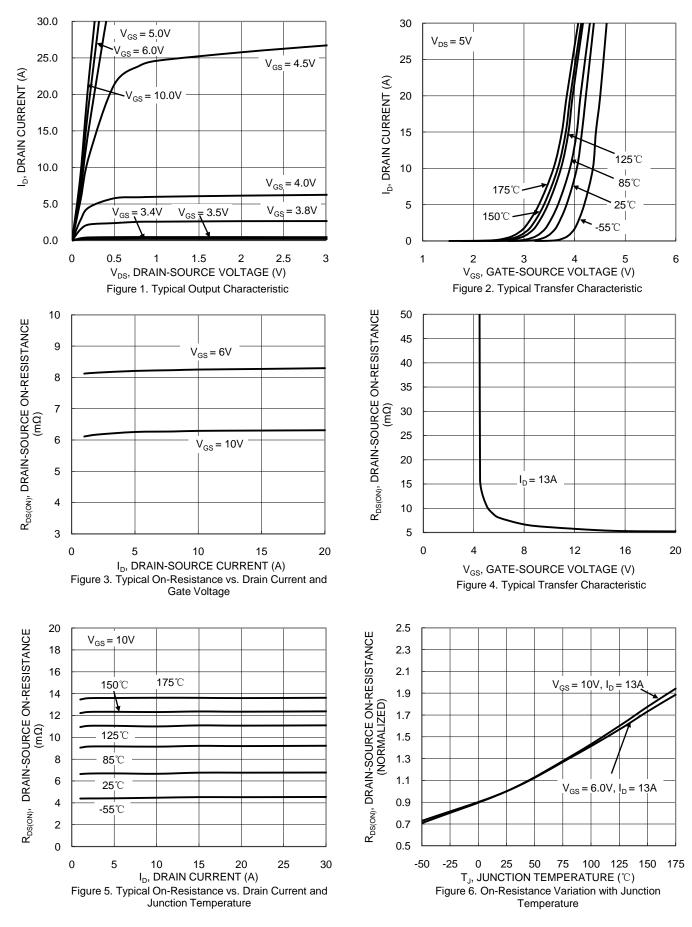
Notes: 6. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

Thermal resistance from junction to soldering point (on the exposed drain pad).
Short duration pulse test used to minimize self-heating effect.

Guaranteed by design. Not subject to product testing
Package limited.

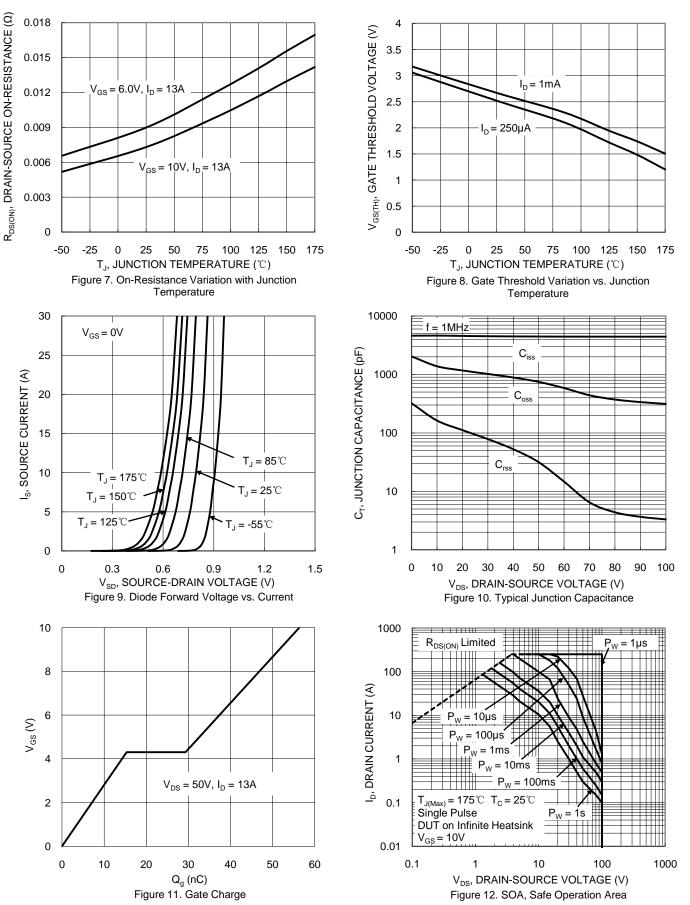


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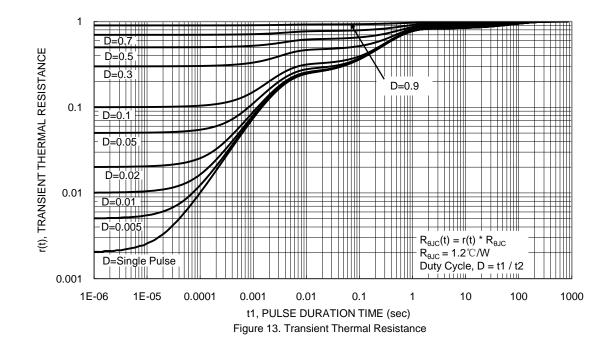
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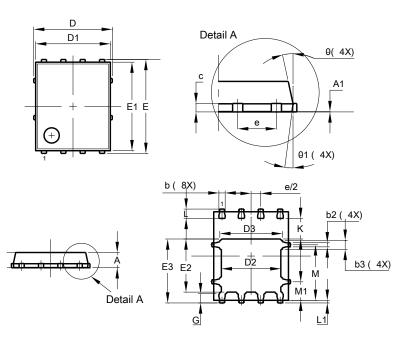




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8

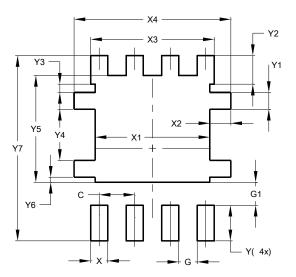


	PowerDI5060-8					
Dim	Min	Max	Тур			
Α	0.90	1.10	1.00			
A1	0.00	0.05	-			
b	0.33	0.51	0.41			
b2	0.200	0.350	0.273			
b3	0.40	0.80	0.60			
С	0.230	0.330	0.277			
D		5.15 BSC	;			
D1	4.70	5.10	4.90			
D2	3.70	4.10	3.90			
D3	3.90 4.30 4.10					
E	6.15 BSC					
E1	5.60	6.00	5.80			
E2	3.28	3.68	3.48			
E3	3.99	4.39	4.19			
е	1.27 BSC					
G	0.51	0.71	0.61			
K	0.51	-	-			
L	0.51	0.71	0.61			
L1	0.100	0.200	0.175			
М	3.235	4.035	3.635			
M1	1.00	1.40	1.21			
Θ	10°	12°	11°			
Θ1	6°	8°	7°			
Al	All Dimensions in mm					

#### **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
X3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610



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